

BSH114

N-channel enhancement mode field effect transistor

Rev. 01 — 09 November 2000 Product s

Product specification

Description

N-channel enhancement mode field-effect transistor in a plastic package using TrenchMOS™¹ technology.

Product availability:

BSH114 in SOT23.

Features

- TrenchMOS[™] technology
- Low on-state resistance
- Very fast switching
- Surface mount package.

Applications

- Relay driver
- DC to DC converter
- General purpose switch.

Pinning information

Table 1: Pinning - SOT23, simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1	gate (g)	3	
2	source (s)		d
3	drain (d)	1 2 Top view	g

TrenchMOS is a trademark of Royal Philips Electronics.





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5. Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Тур	Max	Unit
V_{DS}	drain-source voltage (DC)	T _j = 25 to 150 °C	-	100	V
I _D	drain current (DC)	T_{sp} = 25 °C; V_{GS} = 10 V	-	0.85	Α
P _{tot}	total power dissipation	T _{sp} = 25 °C	-	0.83	W
Tj	junction temperature		_	150	°C
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 0.5 \text{ A}$	400	500	mΩ

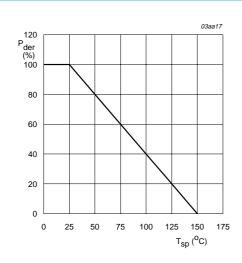
6. Limiting values

Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

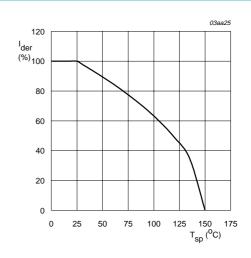
Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage (DC)	T _j = 25 to 150 °C	_	100	V
V_{DGR}	drain-gate voltage (DC)	T_j = 25 to 150 °C; R_{GS} = 20 $k\Omega$	_	100	V
V_{GS}	gate-source voltage (DC)		_	±20	V
I _D	drain current (DC)	T_{sp} = 25 °C; V_{GS} = 10 V; Figure 2 and 3	_	0.85	Α
		T_{sp} = 100 °C; V_{GS} = 10 V; Figure 2 and 3	_	0.5	Α
		T _{amb} = 25 °C; V _{GS} = 10 V	_	0.5	Α
		T _{amb} = 100 °C; V _{GS} = 10 V	_	0.3	Α
I _{DM}	peak drain current	T_{sp} = 25 °C; $t_p \le 10 \mu s$; Figure 3	_	3.4	Α
P _{tot}	total power dissipation	T _{sp} = 25 °C; Figure 1	_	0.83	W
		T _{amb} = 25 °C	_	0.36	W
T _{stg}	storage temperature		-55	+150	°C
Tj	operating junction temperature		-55	+150	°C
Source-d	drain (reverse) diode				
Is	source (diode forward) current (DC)	T _{sp} = 25 °C	_	0.85	Α
I _{SM}	peak (diode forward) source current	$T_{sp} = 25 ^{\circ}C; t_p \le 10 \mu s$	_	3.4	Α

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$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

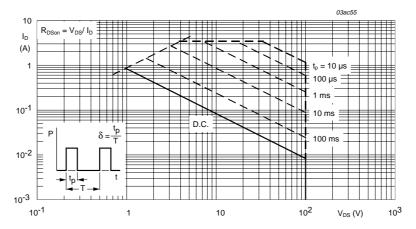
Fig 1. Normalized total power dissipation as a function of solder point temperature.



$$V_{GS} \ge 10 \text{ V}$$

$$I_D = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100\%$$

Fig 2. Normalized continuous drain current as a function of solder point temperature.



 $T_{sp} = 25 \,^{\circ}\text{C}$; I_{DM} is single pulse

Fig 3. Safe operating area; drain and peak currents as a function of drain source voltage.

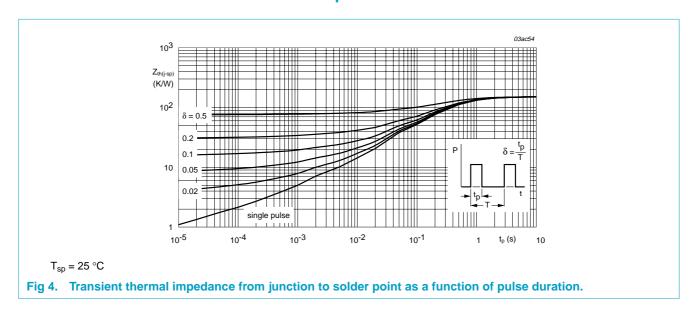
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7. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	mounted on a metal clad substrate; Figure 4	150	K/W
$R_{th(j-amb)}$	thermal resistance from junction to ambient	mounted on a printed circuit board; minimum footprint	350	K/W

7.1 Transient thermal impedance



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8. Characteristics

Table 5: Characteristics

 $T_i = 25 \,^{\circ}C$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \mu\text{A}; V_{GS} = 0 \text{V}$				
		T _j = 25 °C	100	130	_	V
		T _j = −55 °C	95	_	_	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; Figure 9				
		T _j = 25 °C	2	3	4	V
		T _j = 150 °C	1.2	_	_	V
		T _j = −55 °C	_	_	6	V
I _{DSS}	drain-source leakage current	V _{DS} = 100 V; V _{GS} = 0 V				
		T _j = 25 °C	_	1	25	μΑ
		T _j = 150 °C	_	4	250	μΑ
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$	_	10	100	nΑ
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 0.5 A; Figure 7 and 8				
		T _j = 25 °C	_	400	500	$m\Omega$
		T _j = 150 °C	_	_	1.15	Ω
Dynamic	characteristics					
g _{fs}	forward transconductance	V _{DS} = 20 V; I _D = 0.5 A; Figure 11	0.5	1.2	_	S
Q _{g(tot)}	total gate charge	$I_D = 0.5 \text{ A}$; $V_{DD} = 80 \text{ V}$; $V_{GS} = 10 \text{ V}$; Figure 14	_	4.6	_	nC
Q _{gs}	gate-source charge		_	0.8	_	nC
Q _{gd}	gate-drain (Miller) charge		_	2.1	_	nC
C _{iss}	input capacitance	$V_{GS} = 0 \text{ V}; V_{DD} = 25 \text{ V}; f = 1 \text{ MHz}; Figure 12$	_	138	_	pF
Coss	output capacitance		_	21	_	pF
C _{rss}	reverse transfer capacitance		_	12	_	pF
t _{d(on)}	turn-on delay time	V_{DD} = 50 V; R_D = 100 Ω ; V_{GS} = 10 V; R_G = 6 Ω	_	6	_	ns
t _r	rise time		_	13	_	ns
t _{d(off)}	turn-off delay time		_	8	_	ns
t _f	fall time		_	5	_	ns
Source-c	drain (reverse) diode					
V _{SD}	source-drain (diode forward) voltage	$I_S = 0.85 \text{ A}; V_{GS} = 0 \text{ V}; Figure 13$	_	0.84	1	V
t _{rr}	reverse recovery time	$I_S = 0.5 \text{ A}$; $dI_S/dt = -100 \text{ A/}\mu\text{s}$;	_	24	_	ns
Q _r	recovered charge	$V_{GS} = 0 \text{ V}; V_{DS} = 30 \text{ V}$	_	37	_	nC

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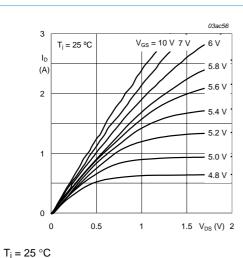
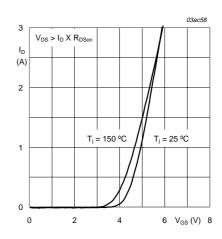
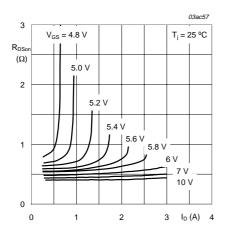


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values.



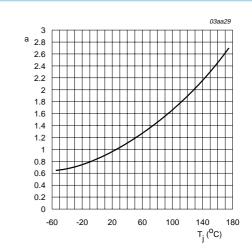
 T_j = 25 °C and 150 °C; $V_{DS} > I_D x R_{DSon}$

Fig 6. Transfer characteristic: drain current as a function of gate-source voltage; typical values.



 $T_j = 25 \, ^{\circ}C$

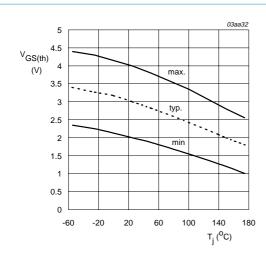
Fig 7. Drain-source on-state resistance as a function of drain current; typical values.



 $a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$

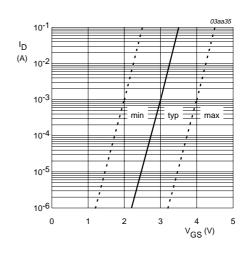
Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature.

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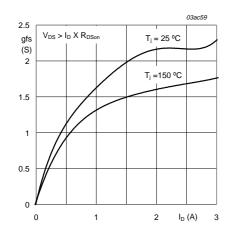
 $I_D = 1 \text{ mA}; V_{DS} = V_{GS}$

Fig 9. Gate-source threshold voltage as a function of junction temperature.



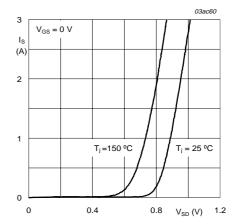
 $T_i = 25 \,^{\circ}C; \, V_{DS} = 5 \,^{\circ}V$

Fig 10. Sub-threshold drain current as a function of gate-source voltage.



 T_j = 25 °C and 150 °C; $V_{DS} > I_D x R_{DSon}$

Fig 11. Forward transconductance as a function of drain current; typical values.



 $V_{GS} = 0 V$; f = 1 MHz

Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values.

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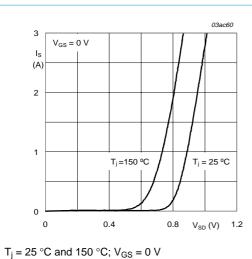
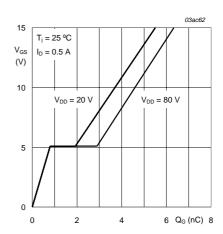


Fig 13. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values.



 $I_D = 0.5 \text{ A}; V_{DD} = 20 \text{ V} \text{ and } 80 \text{ V}$

Fig 14. Gate-source voltage as a function of gate charge; typical values.

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Package outline

Plastic surface mounted package; 3 leads

SOT23

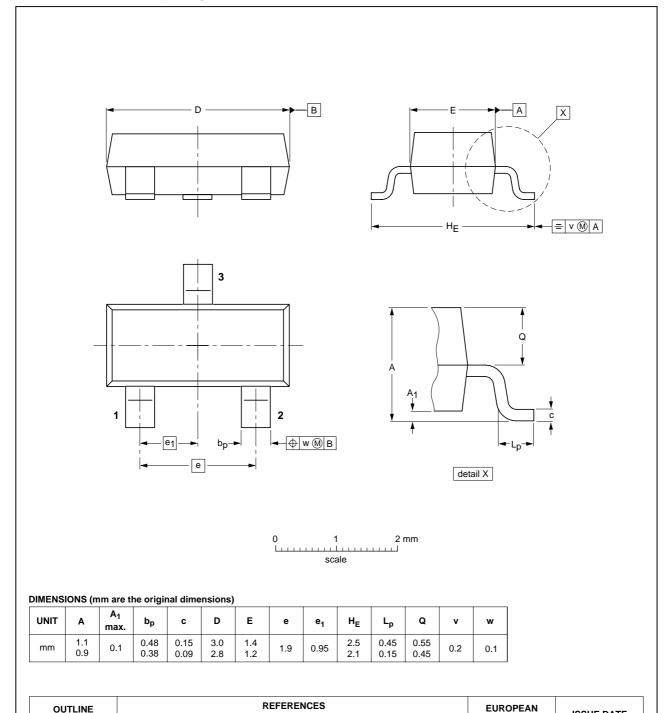


Fig 15. SOT23.

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PROJECTION

EIAJ

JEDEC

TO-236AB

VERSION

SOT23

IEC

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10. Revision history

Table 6: Revision history

Rev	Date	CPCN	Description
01	20001109	-	Product specification; initial version

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11. Data sheet status

Datasheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued data sheet before initiating or completing a design.

12. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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